(LTCC) SURFACE MOUNT

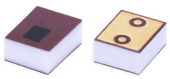
High Pass Filter

HFHK-1600+

50Ω 1900 to 9500 MHz

THE BIG DEAL

- Insertion Loss, Typ. 0.7 dB
- Stopband Rejection, Typ. 78 dB
- Passband Return Loss, Typ. 16 dB
- 1008 Surface Mount Footprint
- Power Handling: 6 W
- Shielded Construction: Prevents De-Tuning & EMI
- Protected by US Patents 11,638,370 and 11,744,057

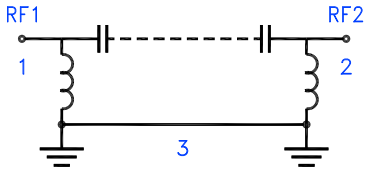


Generic photo used for illustration purposes only

APPLICATIONS

- 5G Sub-6 GHz
- Radar, EW, ECM Defense Systems
- Test and Measurement Equipment
- Telecommunications and Broadband Wireless Systems
- WiFi 6E

FUNCTIONAL DIAGRAM



PRODUCT OVERVIEW

The HFHK-1600+ is a passive RF component designed for signal conditioning in high-frequency circuits. It utilizes ceramic-based construction to achieve stable electrical behaviour across a broad operating range. The device supports bidirectional signal flow and is optimized for integration into compact layouts, making it suitable for dense PCB designs. It's surface-mount format aligns with standard automated assembly processes, and the internal structure is engineered to minimize parasitic effects that could impact performance at microwave frequencies. The component is built to maintain consistent characteristics under varying environmental conditions, contributing to overall system reliability.

ELECTRICAL SPECIFICATIONS[1,2,3] AT +25°C

Parameter		F#	Frequency (MHz)	Min.	Typ.	Max.	Units
Passband	Insertion Loss	F4-F5	1900 - 3000	—	1.3	2.3	dB
		F5-F6	3000 - 8000	—	0.7	1.5	
		F6-F7	8000 - 9500	—	1	2.5	
	Freq. Cut-Off[4]	Fc	1650	—	3	—	dB
	Return Loss	F4-F5	1900 - 3000	—	16	—	dB
		F5-F6	3000 - 8000	—	13	—	
		F6-F7	8000 - 9500	—	13	—	
Stopband	Rejection	DC-F1	DC - 450	67	78	—	dB
		F1-F2	450 - 900	40	49	—	
		F2-F3	900 - 1200	20	29	—	

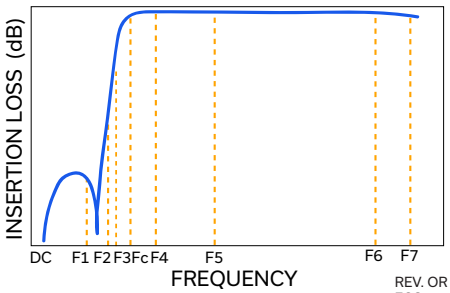
1. Tested in Evaluation Board P/N TB-HFHK-1600+.
2. This filter is bi-directional RF1 and RF2 ports may be interchanged, see S-Parameters for actual performance.
3. This component should not be used as a DC-block. In applications where DC voltage and/or current is present at either the input or output ports, external DC blocking capacitors are required.
4. Typical variation ± 5%

ABSOLUTE MAXIMUM RATINGS[5]

Operating Temperature	-55°C to +125°C
Storage Temperature	-55°C to +125°C
Input Power[6]	6 W @ +25°C

5. Permanent damage may occur if any of these limits are exceeded.
6. Power rating applies only to signals within the passband. Power rating above +25°C operating temperature decreases linearly to 1 W at +125°C.

TYPICAL FREQUENCY RESPONSE

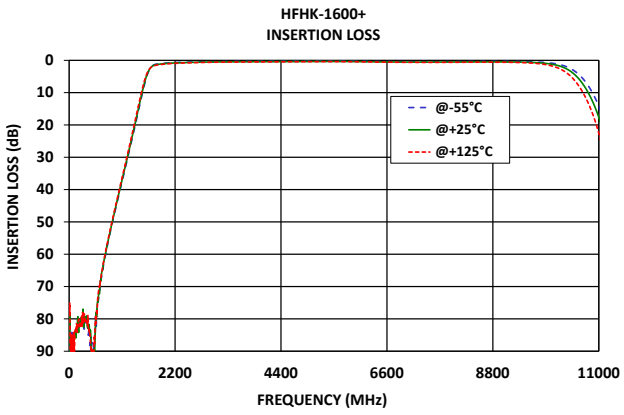


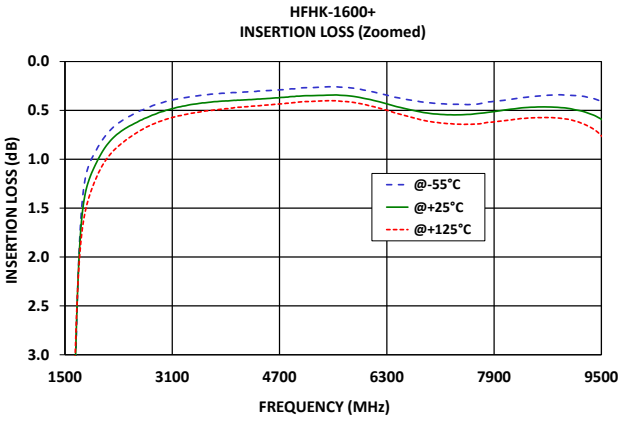
High Pass Filter

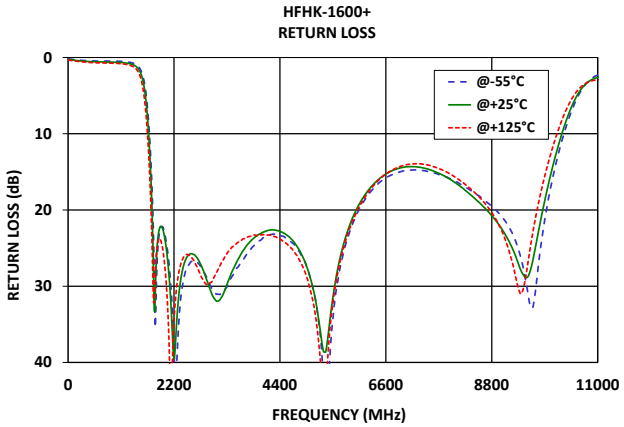
HFHK-1600+

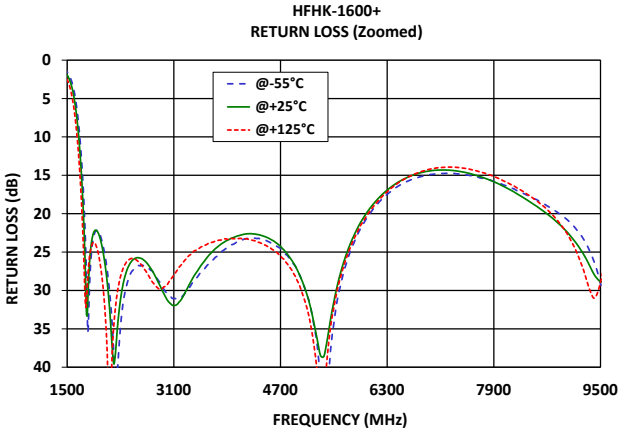
50Ω 1900 to 9500 MHz

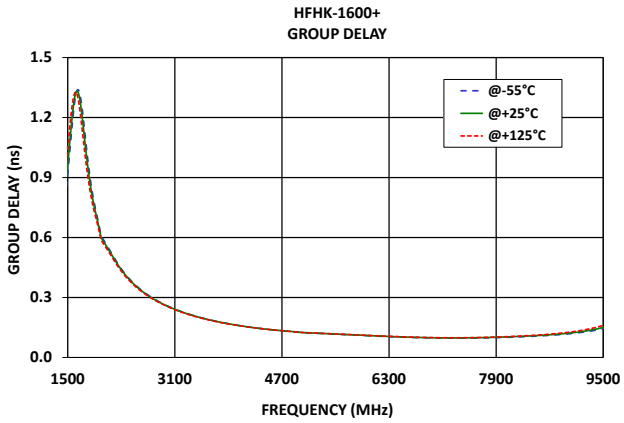
TYPICAL PERFORMANCE GRAPHS











High Pass Filter

HFHK-1600+

50Ω 1900 to 9500 MHz

FUNCTIONAL DIAGRAM

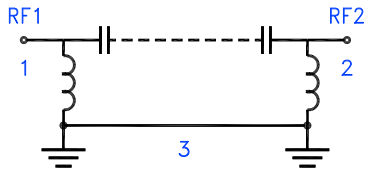
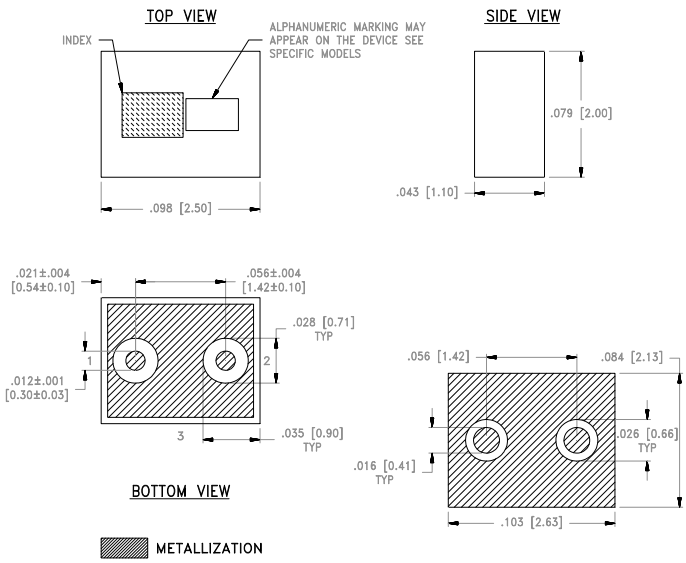


Figure 1. HFHK-1600+ Functional Diagram

PAD DESCRIPTION

Function	Pad Number	Description
RF1[2]	1	Connects to RF Input Port
RF2[2]	2	Connects to RF Output Port
GROUND	3	Connects to Ground on PCB, (See drawing PL-798)

CASE STYLE DRAWING



Weight: .019 grams.
Dimensions are in inches (mm). Tolerances: 2Pl. ± .01; 3Pl. ± .005

PRODUCT MARKING*: V3

*Marking may contain other features or characters for internal lot control.

SUGGESTED PCB LAYOUT

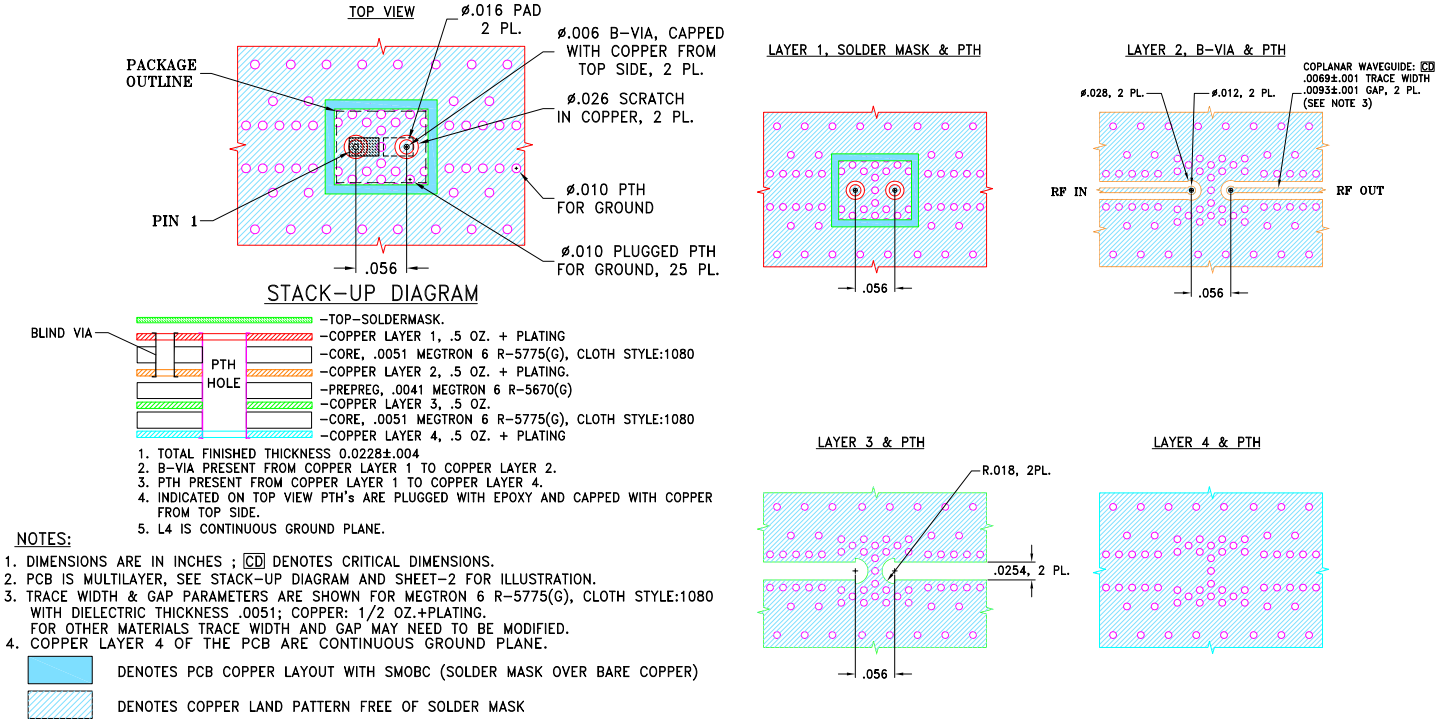


Figure 2. Suggested PCB Layout

High Pass Filter

HFHK-1600+

50Ω 1900 to 9500 MHz

ADDITIONAL DETAILED INFORMATION IS AVAILABLE ON OUR DASHBOARD CLICK HERE

Performance Data & Graphs	Data Graphs S-Parameter (S2P Files) Data Set (.zip file) De-embedded to device pads
Case Style	NL1008C-10 Lead Finish: Gold over Electroless Nickel
RoHS/REACH Status	Compliant
Tape and Reel	F75
Suggested Layout for PCB Design	PL-798
Evaluation Board	TB-HFHK-1600+ Gerber File
Environmental Rating	ENV06T10

NOTES

A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.

B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuits' applicable established test performance criteria and measurement instructions.

C. The parts covered by this specification document are subject to Mini-Circuits' standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the standard terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at www.minicircuits.com/terms/viewterm.html

Ceramic High Pass Filter HFHK-1600+

Typical Performance Data

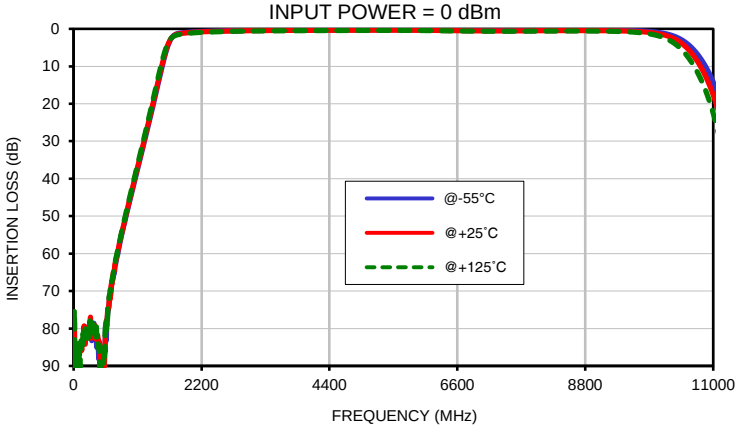
FREQ.	INSERTION LOSS			INPUT RETURN LOSS			OUTPUT RETURN LOSS		
(MHz)	(dB)			(dB)			(dB)		
	@-55°C	@+25°C	@+125°C	@-55°C	@+25°C	@+125°C	@-55°C	@+25°C	@+125°C
10	77.96	82.22	78.26	0.16	0.25	0.32	0.21	0.25	0.34
20	90.97	89.21	87.00	0.17	0.26	0.33	0.19	0.26	0.35
30	98.35	91.07	91.03	0.19	0.27	0.36	0.20	0.27	0.36
40	87.91	88.70	89.51	0.20	0.28	0.37	0.21	0.28	0.37
50	89.85	90.23	85.01	0.21	0.29	0.38	0.22	0.29	0.38
60	86.67	85.16	85.77	0.22	0.30	0.39	0.23	0.30	0.39
70	93.47	89.21	85.04	0.22	0.30	0.40	0.24	0.31	0.40
100	85.65	86.49	85.21	0.25	0.33	0.42	0.26	0.33	0.43
150	83.44	83.03	81.46	0.29	0.37	0.46	0.30	0.37	0.48
300	79.99	82.62	80.23	0.38	0.46	0.57	0.40	0.47	0.61
400	85.07	83.07	83.13	0.42	0.51	0.63	0.44	0.52	0.67
450	85.58	85.01	89.40	0.43	0.53	0.65	0.45	0.54	0.70
700	65.33	64.59	63.41	0.46	0.58	0.70	0.49	0.59	0.74
800	56.88	56.49	56.17	0.46	0.59	0.72	0.49	0.60	0.75
900	50.11	49.77	49.25	0.47	0.60	0.74	0.49	0.61	0.76
1000	43.75	43.29	42.68	0.48	0.62	0.76	0.49	0.62	0.77
1200	31.15	30.62	29.87	0.55	0.72	0.89	0.54	0.70	0.87
1350	21.52	20.92	20.01	0.74	0.95	1.19	0.72	0.91	1.16
1500	11.54	10.95	10.02	1.54	1.93	2.53	1.49	1.85	2.45
1650	3.42	3.26	3.07	6.64	7.94	10.12	6.50	7.72	9.89
1750	1.49	1.61	1.76	18.27	21.42	26.12	17.66	19.92	23.54
1900	0.99	1.14	1.30	22.89	22.40	23.74	22.14	21.59	22.79
1950	0.92	1.06	1.22	22.17	22.28	24.59	21.54	21.55	23.57
2000	0.86	0.99	1.14	22.90	23.42	26.83	22.21	22.54	25.41
2100	0.76	0.88	1.02	27.34	28.88	37.96	26.04	26.93	31.54
2200	0.69	0.79	0.93	38.27	39.58	34.51	33.05	33.29	31.97
2400	0.58	0.68	0.81	29.07	27.26	26.17	29.54	28.16	26.73
2500	0.55	0.65	0.76	27.25	25.92	25.90	28.01	27.07	26.91
2700	0.48	0.58	0.68	26.98	26.48	27.79	28.72	28.50	31.14
2900	0.43	0.52	0.62	29.06	29.51	29.77	33.51	34.78	38.83
3000	0.41	0.50	0.59	30.38	31.23	29.28	39.41	42.41	34.26
3200	0.38	0.46	0.55	31.01	31.32	26.78	37.86	34.93	27.68
3400	0.36	0.44	0.53	28.76	28.15	24.88	29.05	28.21	24.52
3600	0.34	0.42	0.51	26.73	25.69	23.98	25.62	25.09	23.02
3800	0.33	0.41	0.49	25.10	24.02	23.44	23.66	23.22	22.25
4000	0.32	0.40	0.48	23.95	23.09	23.26	22.62	22.27	22.03
4200	0.31	0.39	0.46	23.23	22.62	23.29	22.11	21.82	22.13
4400	0.30	0.38	0.45	23.34	22.80	23.82	22.40	22.03	22.77
4600	0.30	0.37	0.44	23.93	23.57	24.76	23.38	22.89	24.02
4800	0.29	0.36	0.43	25.44	25.24	26.52	25.35	24.62	26.12
4900	0.28	0.36	0.42	26.60	26.51	27.87	26.93	25.97	27.72
5000	0.27	0.35	0.41	28.26	28.23	29.71	28.91	27.72	29.80
5200	0.27	0.35	0.41	34.48	34.19	37.06	36.37	32.73	35.98
5400	0.26	0.34	0.40	43.87	36.48	38.76	37.17	33.11	33.81
5600	0.26	0.34	0.41	29.38	27.73	28.30	28.13	26.93	27.20
5800	0.27	0.36	0.42	23.83	22.88	23.33	23.42	22.65	23.01
5900	0.28	0.37	0.43	21.95	21.16	21.55	21.74	21.07	21.46
6000	0.30	0.38	0.44	20.48	19.79	20.17	20.36	19.76	20.14
6200	0.33	0.41	0.48	18.29	17.72	18.00	18.26	17.73	18.10
6400	0.36	0.45	0.52	16.79	16.27	16.42	16.93	16.33	16.64
6600	0.39	0.49	0.56	15.80	15.28	15.28	16.00	15.36	15.55
6800	0.41	0.51	0.59	15.19	14.68	14.54	15.40	14.76	14.84
7000	0.43	0.54	0.62	14.85	14.36	14.11	15.11	14.44	14.45
7400	0.44	0.54	0.64	14.84	14.52	14.02	15.12	14.59	14.39
7800	0.41	0.52	0.62	15.57	15.49	14.84	15.61	15.50	15.05
8000	0.40	0.50	0.61	16.08	16.24	15.53	15.97	16.17	15.60
8500	0.36	0.47	0.58	18.03	18.80	18.07	17.50	18.54	17.72
9000	0.34	0.48	0.59	20.78	22.40	22.61	20.13	22.11	22.02
9200	0.35	0.51	0.63	22.71	24.66	26.28	22.17	24.71	26.15
9500	0.41	0.59	0.76	29.09	28.86	28.93	29.43	34.92	36.90

Typical Performance Data

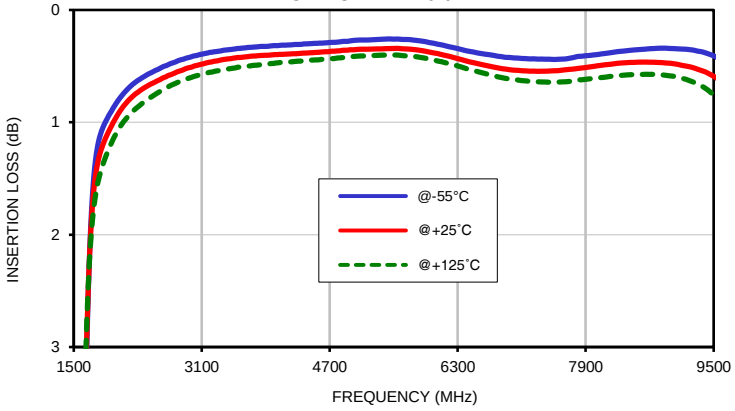
FREQ. (MHz)	GROUP DELAY (nsec)		
	@-55°C	@+25°C	@+125°C
1900	0.77	0.75	0.72
2000	0.61	0.60	0.59
2100	0.55	0.54	0.53
2300	0.44	0.44	0.43
2500	0.37	0.36	0.36
2700	0.31	0.31	0.31
3000	0.26	0.25	0.25
3200	0.23	0.23	0.23
3400	0.21	0.21	0.21
3600	0.19	0.19	0.19
3800	0.18	0.17	0.17
3900	0.17	0.17	0.17
4000	0.16	0.16	0.16
4200	0.15	0.15	0.15
4400	0.14	0.14	0.14
4600	0.14	0.14	0.14
4800	0.13	0.13	0.13
4900	0.13	0.13	0.13
5000	0.12	0.12	0.13
5200	0.12	0.12	0.12
5400	0.12	0.12	0.12
5600	0.11	0.12	0.12
5800	0.11	0.11	0.11
5900	0.11	0.11	0.11
6000	0.11	0.11	0.11
6200	0.11	0.11	0.11
6400	0.10	0.10	0.10
6600	0.10	0.10	0.10
6800	0.10	0.10	0.10
6900	0.10	0.10	0.10
7000	0.10	0.10	0.10
7200	0.10	0.10	0.10
7400	0.10	0.10	0.10
7600	0.10	0.10	0.10
7800	0.10	0.10	0.10
8000	0.10	0.10	0.10
8200	0.10	0.10	0.11
8500	0.11	0.11	0.11
9000	0.12	0.12	0.13
9500	0.14	0.15	0.16

Typical Performance Curves

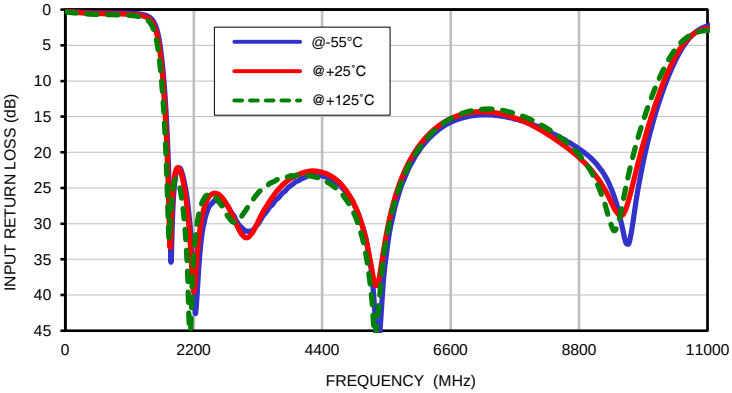
INSERTION LOSS vs. TEMPERATURE
INPUT POWER = 0 dBm



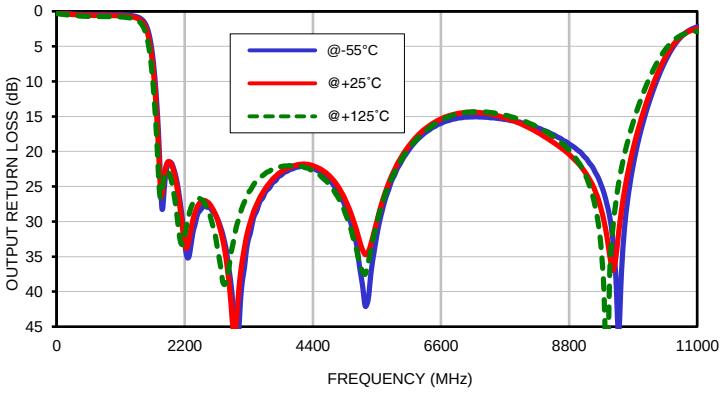
INSERTION LOSS vs. TEMPERATURE (Zoomed)
INPUT POWER = 0 dBm



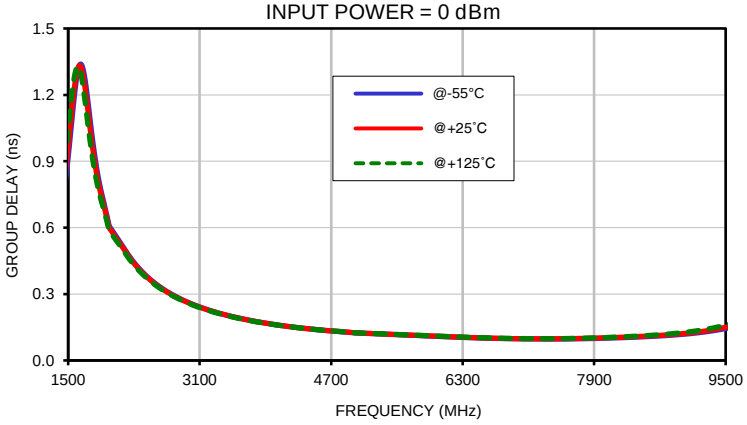
INPUT RETURN LOSS vs. TEMPERATURE
INPUT POWER = 0 dBm



OUTPUT RETURN LOSS vs. TEMPERATURE
INPUT POWER = 0 dBm

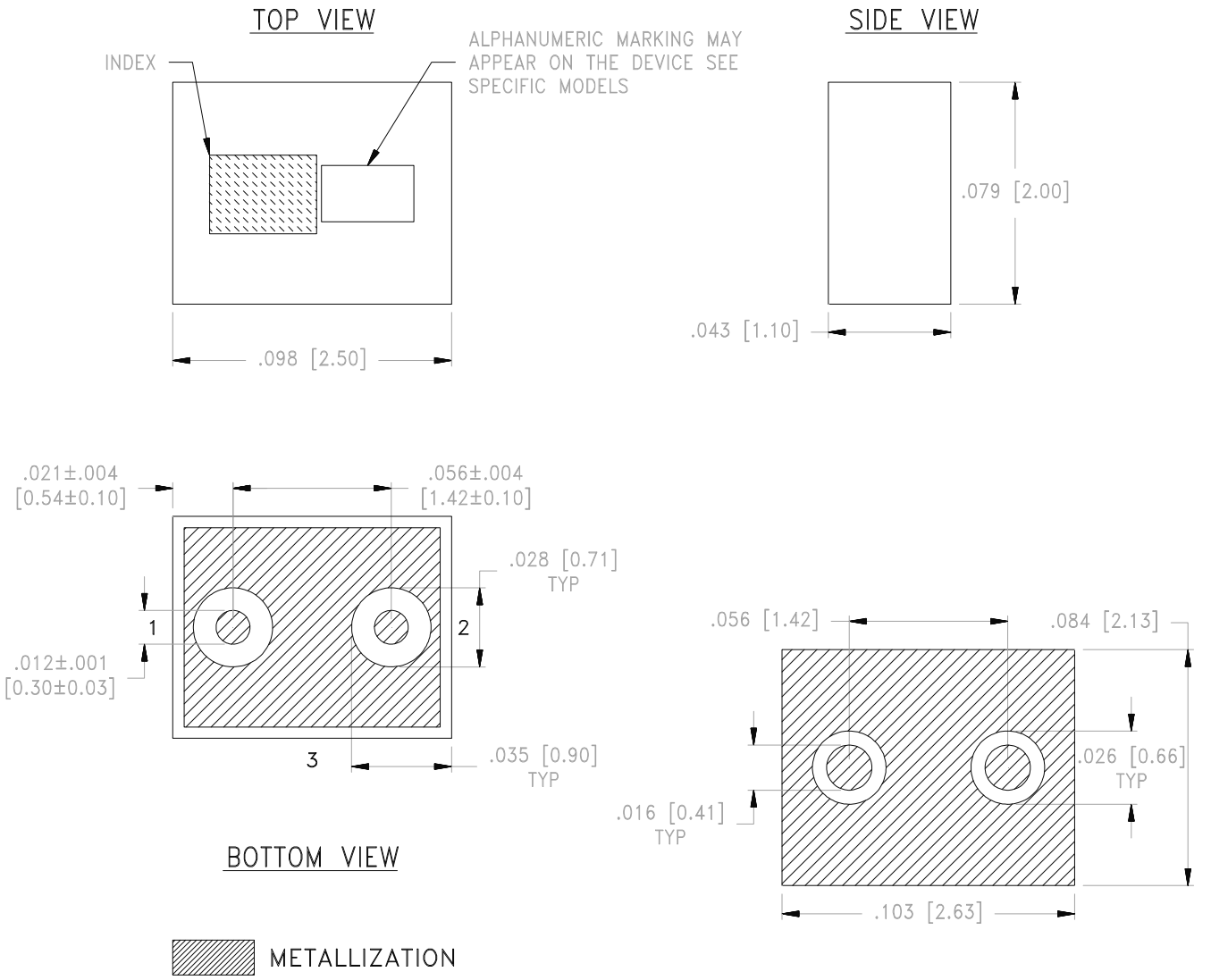


GROUP DELAY vs. TEMPERATURE
INPUT POWER = 0 dBm



Case Style NL

Outline Dimensions NL1008C-10



SUGGESTED LAYOUT FOR PCB LAND PATTERN

PATTERN TO BE WITHIN ±.002

Dimensions are in inches (mm). Tolerances: 2Pl. ± .01; 3Pl. ± .005

Notes:

1. Open style, Ceramic base.
2. Termination finish: **as shown below or indicated on Data sheet.**
   For RoHS Case Styles: Gold plate over nickel plate. All models, (+) suffix.
3. Weight: .019 grams.
4. Pad tolerance is non-cumulative.

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Tape & Reel Packaging TR-F75

DEVICE ORIENTATION IN T&R

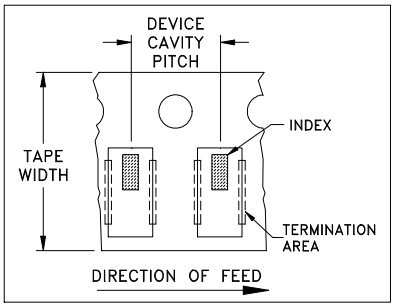

ILLUSTRATION 1

Applicable Case Styles
FV1206-1
FV1206-3

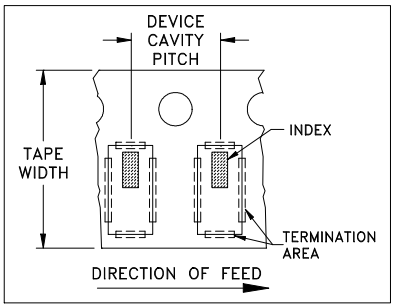

ILLUSTRATION 2

Applicable Case Styles
FV1206-4
FV1206-5
FV1206-6
FV1206-7
FV1206-9

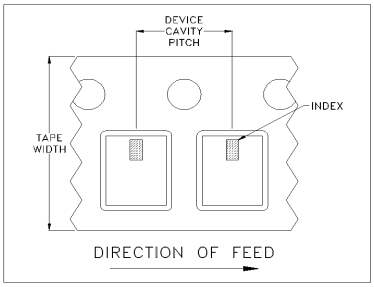

ILLUSTRATION 3

Applicable Case Styles
FV1206-11
FV1206-12
GE0805C-18
NL1008C-6
NL1008C-7
NL1008C-9
NL1008C-10
NL1008C-12

Tape Width, mm	Device Cavity Pitch, mm	Reel Size, inches	Devices per Reel	
8	4	7	Small quantity standards (see note)	20
				50
				100
				200
				500
				1000
			Standard	3000

Note: Please consult individual model data sheet to determine device per reel availability.

Mini-Circuits carrier tape materials provide protection from ESD (Electro-Static Discharge) during handling and transportation. Tapes are static dissipative and comply with industry standards EIA-481/EIA-541.

Go to: www.minicircuits.com/pages/pdfs/tape.pdf

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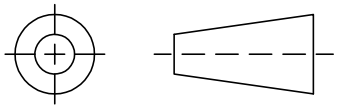
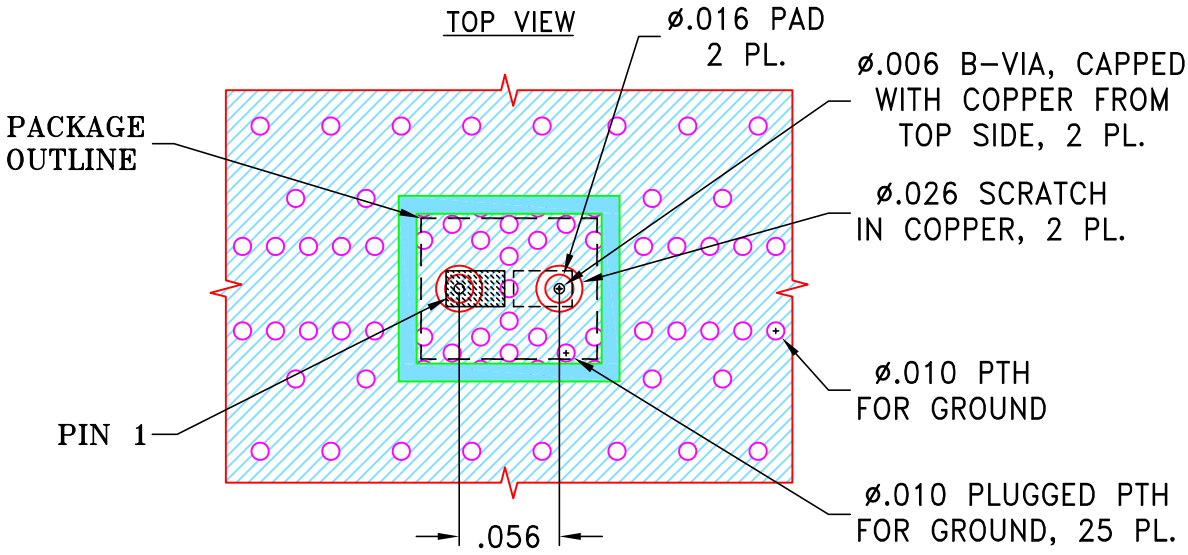
THIRD ANGLE PROJECTION

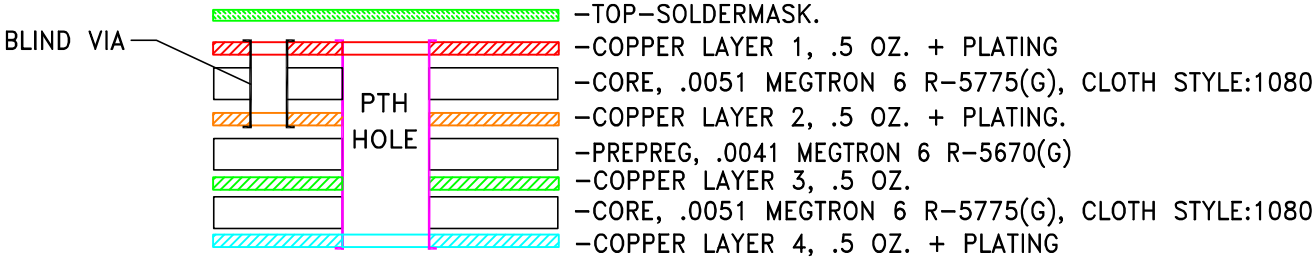


REVISIONS					
REV	ECN No.	DESCRIPTION	DATE	DR	AUTH
OR	ECO-023057	NEW RELEASE	SEP 24	AGS	GT

SUGGESTED MOUNTING CONFIGURATION FOR NL1008C-9 CASE STYLE



STACK-UP DIAGRAM



1. TOTAL FINISHED THICKNESS 0.0228±.004 .
2. B-VIA PRESENT FROM COPPER LAYER 1 TO COPPER LAYER 2.
3. PTH PRESENT FROM COPPER LAYER 1 TO COPPER LAYER 4.
4. INDICATED ON TOP VIEW PTH's ARE PLUGGED WITH EPOXY AND CAPPED WITH COPPER FROM TOP SIDE.
5. L4 IS CONTINUOUS GROUND PLANE.

NOTES:

1. PCB IS MULTILAYER, SEE STACK-UP DIAGRAM AND SHEET-2 FOR ILLUSTRATION.
2. TRACE WIDTH & GAP PARAMETERS ARE SHOWN FOR MEGTRON6 R-5775(G), CLOTH STYLE:1080 WITH DIELECTRIC THICKNESS .0051; COPPER: 1/2 OZ.+PLATING.
   FOR OTHER MATERIALS TRACE WIDTH AND GAP MAY NEED TO BE MODIFIED.
3. COPPER LAYER 4 OF THE PCB ARE CONTINUOUS GROUND PLANE.

DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER)

DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

UNLESS OTHERWISE SPECIFIED		INITIALS	DATE
DIMENSIONS ARE IN INCHES	DRAWN	AGS	14 SEP 24
TOLERANCES ON:	CHECKED	MD	16 SEP 24
2 PL DECIMALS ±	APPROVED	GTP	17 SEP 24
3 PL DECIMALS ± .002			
ANGLES ±			
FRACTIONS ±			

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ASHEETA1.DWG REV:A DATE:01/12/95

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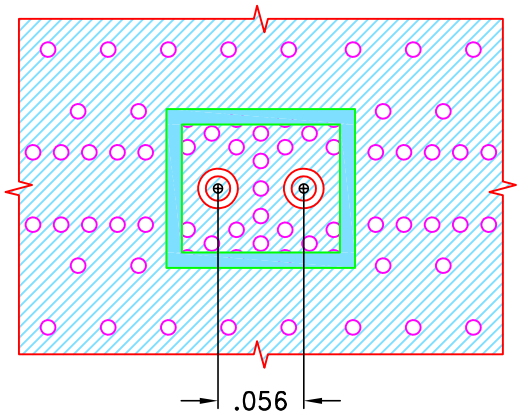
13 Neptune Avenue
Brooklyn NY 11235

PL, NL1008C-9, TB-LFHK-XXXX+

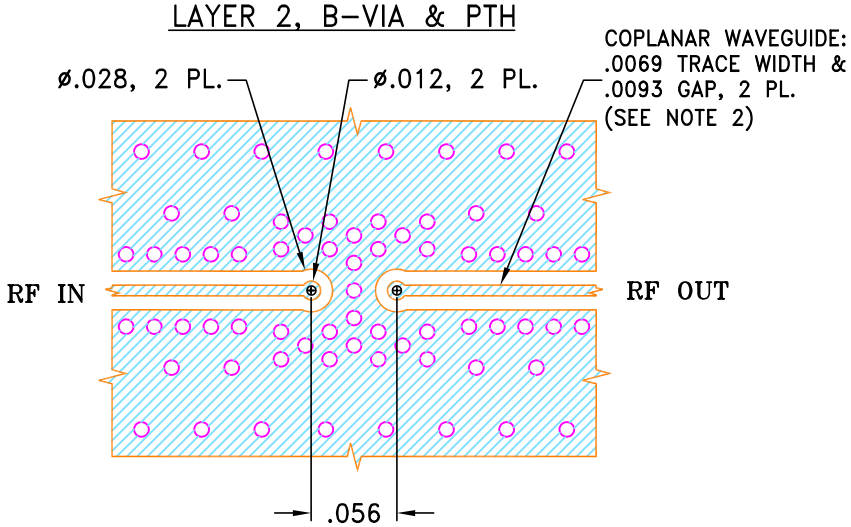
SIZE	CODE IDENT	DRAWING NO:	REV:
A	15542	98-PL-798	OR

FILE:	SCALE:	SHEET:
98-PL-798	9:1	1 OF 2

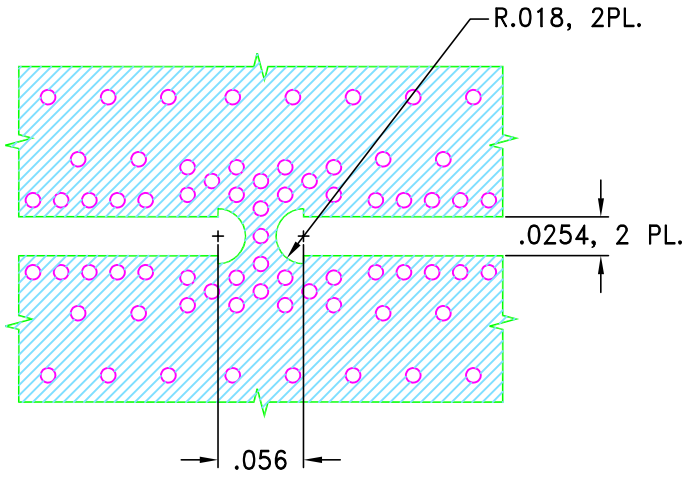
LAYER 1, SOLDER MASK & PTH



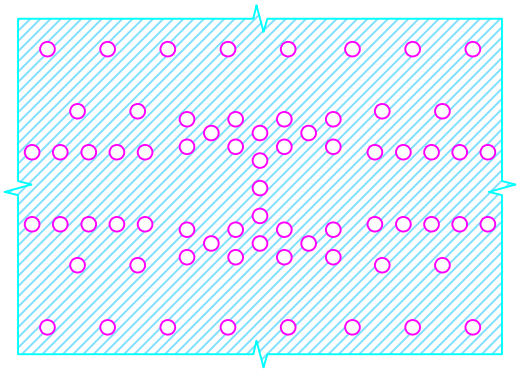
LAYER 2, B-VIA & PTH



LAYER 3 & PTH



LAYER 4 & PTH



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ASHEETA2.DWG REV:A DATE: 01/12/94

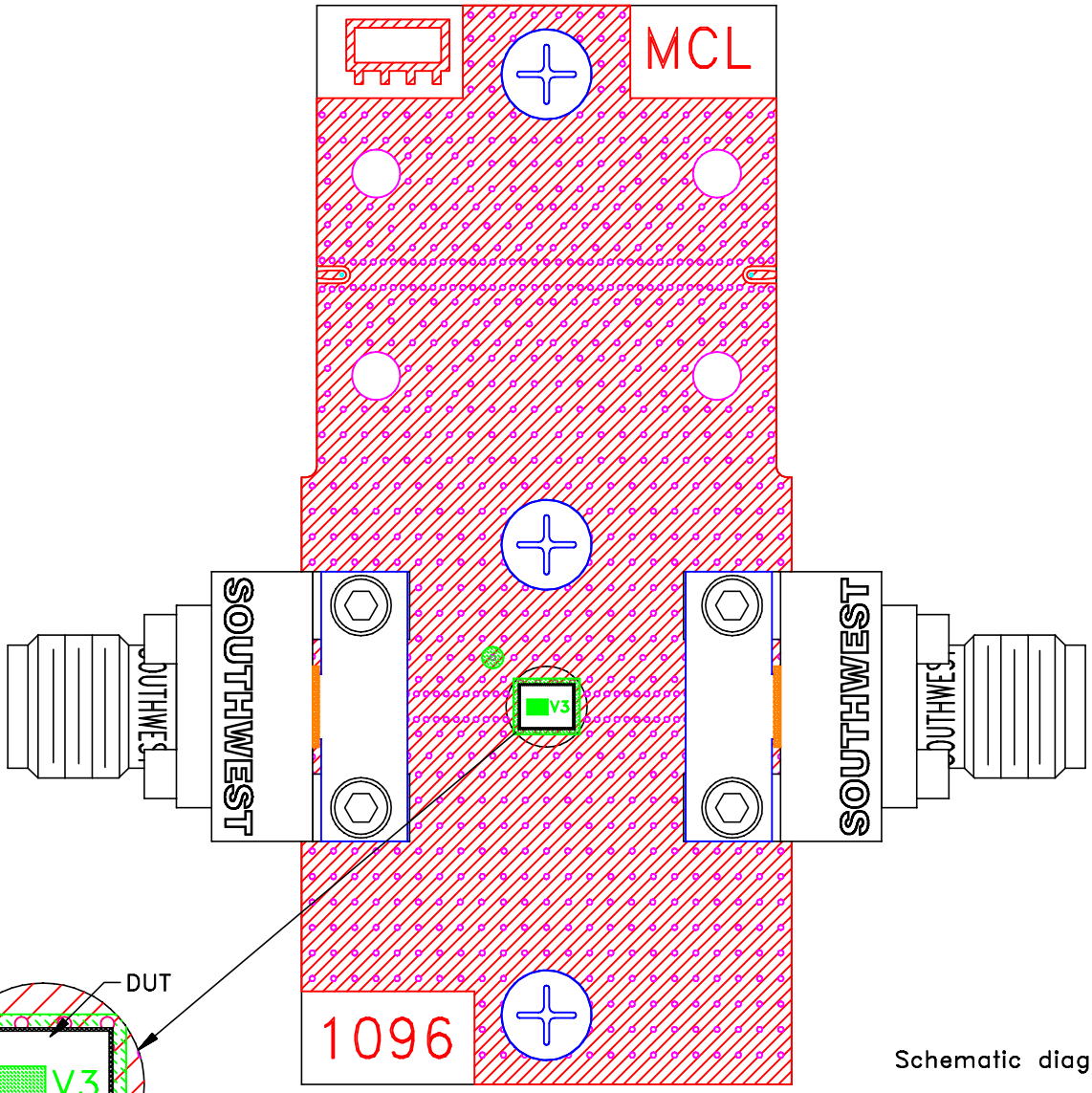
ALL DIMENSIONS ARE IN INCHES EXCEPT OTHERWISE SPECIFIED

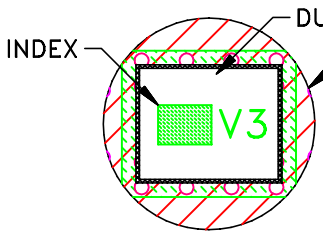
SIZE	CODE IDENT	DRAWING NO:	REV:
A	15542	98-PL-798	OR

FILE:	SCALE:	SHEET:
98-PL-798	7.7:1	2 OF 2

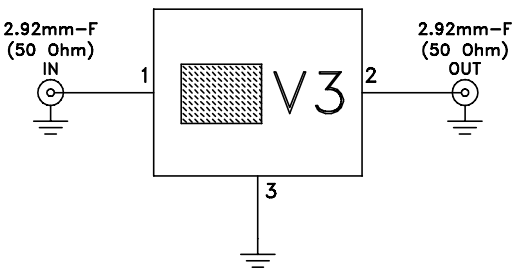
Evaluation Board and Circuit

TB-HFHK-1600+

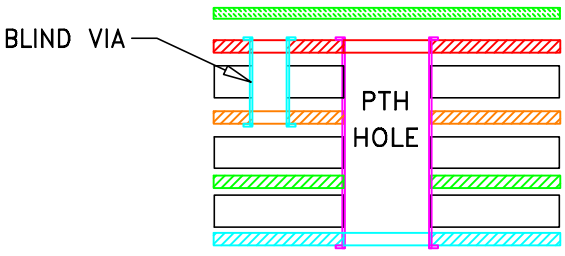




Schematic diagram



STACK-UP DIAGRAM



-TOP-SOLDERMASK.
-COPPER LAYER 1, .5 OZ. + PLATING
-CORE, .0051 MEGTRON 6 R-5775(G), CLOTH STYLE:1080
-COPPER LAYER 2, .5 OZ. + PLATING.
-PREPREG, .0041 MEGTRON 6 R-5670(G)
-COPPER LAYER 3, .5 OZ.
-CORE, .0051 MEGTRON 6 R-5775(G), CLOTH STYLE:1080
-COPPER LAYER 4, .5 OZ. + PLATING

Notes:

1. PCB Material: MEGTRON-6 R5775(G) OR Equivalent, Dielectric Constant=3.6
2. Total finished thickness: .023 inch
3. 50 Ohm 2.92mm Female End Launch Connector.

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Environmental Specifications ENV06T10

All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-55° to 125° C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 125° C Ambient Environment	Individual Model Data Sheet
Humidity	90 to 95% RH, 240 hours, 50°C	MIL-STD-202, Method 103, Condition A, Except 50°C and end-point electrical test done within 12 hours
Solder Reflow Heat	Sn-Pb Eutectic Process 225°C peak Pb-Free Process 245° - 250°C peak	J-STD-020C, Table 4-1, 4-2 and 5-2, Figure 5-1
Solderability	10X Magnification	J-STD-002, Test B,B1, 95% Coverage
Thermal Shock	-55° to +125°C, 15 min dwell,250 cycles	MIL-STD-202, Method 107
Bend Test	1mm, deflection for 5 seconds Span of bending: 2.75"	--
High Temp Storage	125°C to 1000 Hrs	---

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